

NCE N-Channel Enhancement Mode Power MOSFET

Description

The NCE0140IA uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.

General Features

V_{DS} = 100V,I_D =40A

 $R_{DS(ON)} < 17m\Omega$ @ $V_{GS}=10V$ (Typ:12m Ω)

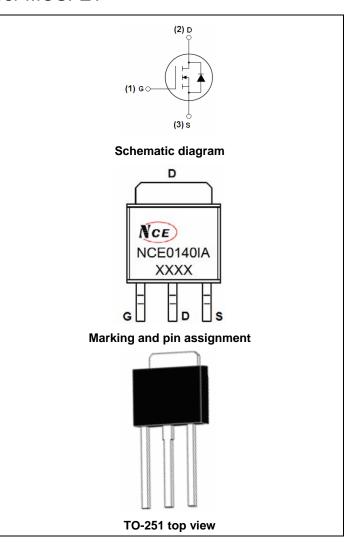
 $R_{DS(ON)} < 18m\Omega @ V_{GS}=4.5V$ (Typ:13m Ω)

- Special process technology for high ESD capability
- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high E_{AS}
- Excellent package for good heat dissipation

Application

- Power switching application
- Hard switched and high frequency circuits
- Uninterruptible power supply

100% UIS TESTED! 100% ΔVds TESTED!



Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE0140IA	NCE0140IA	TO-251	-	-	-

Absolute Maximum Ratings (T_C=25℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	VDS	100	V
Gate-Source Voltage	V _{GS}	±20	V
Drain Current-Continuous	I _D	40	А
Drain Current-Continuous(T _C =100 °C)	I _D (100℃)	28	Α
Pulsed Drain Current	I _{DM}	160	Α
Maximum Power Dissipation	P _D	140	W
Derating factor	-	0.93	W/℃
Single pulse avalanche energy (Note 5)	E _{AS}	400	mJ
Operating Junction and Storage Temperature Range	T_{J} , T_{STG}	-55 To 175	$^{\circ}$ C



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Thermal Characteristic

Thermal Resistance, Junction-to-Case ^(Note 2)	R _{eJC}	1.07	°C/W	Ī
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Electrical Characteristics (T_C=25°C unless otherwise noted)

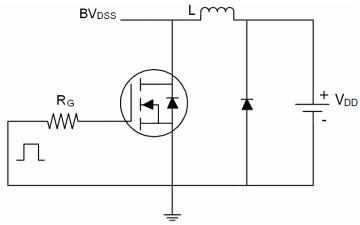
Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics	•		•	•		
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250μA	100	110	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =100V,V _{GS} =0V	-	-	1	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)	<u>.</u>			•		
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS}$, $I_{D}=250\mu A$	0.9	1.1	1.5	V
Drain Source On State Besistance	Б	V _{GS} =10V, I _D =20A	I _D =20A - 12	17		
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =4.5V, I _D =20A	-	13	18	mΩ
Forward Transconductance	g FS	V _{DS} =5V,I _D =20A	32	-	-	S
Dynamic Characteristics (Note4)	<u>.</u>			•		
Input Capacitance	C _{lss}	V _{DS} =30V,V _{GS} =0V,	-	3400	-	PF
Output Capacitance	C _{oss}		-	290	_	PF
Reverse Transfer Capacitance	C _{rss}	F=1.0MHz	-	221	_	PF
Switching Characteristics (Note 4)	•					
Turn-on Delay Time	t _{d(on)}		-	15	-	nS
Turn-on Rise Time	t _r	V_{DD} =30V, I_D =2A, R_L =15 Ω ,	-	11	_	nS
Turn-Off Delay Time	t _{d(off)}	R_G =2.5 Ω , V_{GS} =10 V	-	52	_	nS
Turn-Off Fall Time	t _f		-	13	_	nS
Total Gate Charge	Qg		-	94	_	nC
Gate-Source Charge	Q _{gs}	I _D =20A,V _{DD} =50V,V _{GS} =10V	-	16	_	nC
Gate-Drain Charge	Q _{gd}		-	24	_	nC
Drain-Source Diode Characteristics	<u>.</u>			•		
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =20A	-	0.85	1.2	V
Diode Forward Current (Note 2)	Is		-	-	40	Α
Reverse Recovery Time	t _{rr}	T _J = 25°C, I _F = 20A	-	33		nS
Reverse Recovery Charge	Qrr	di/dt = 100A/µs ^(Note3)	-	54		nC
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is neglig	ible (turn	-on is do	minated by	y LS+LD)

Notes:

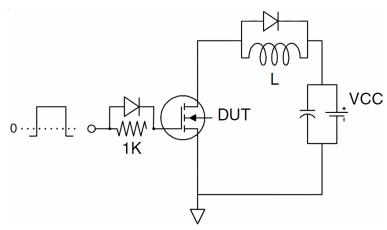
- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, t ≤ 10 sec.
- 3. Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2%.
- **4.** Guaranteed by design, not subject to production
- **5.** EAS condition: Tj=25 $^{\circ}$ C,V_{DD}=50V,V_G=10V,L=0.5mH,Rg=25 Ω

Test Circuit

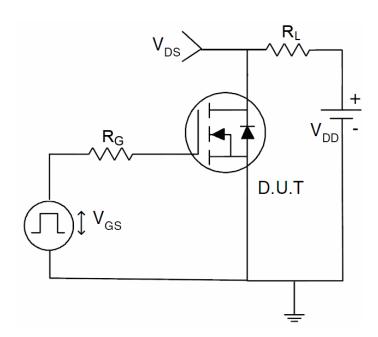
1) E_{AS} test Circuit



2) Gate charge test Circuit



3) Switch Time Test Circuit







Typical Electrical and Thermal Characteristics (Curves)

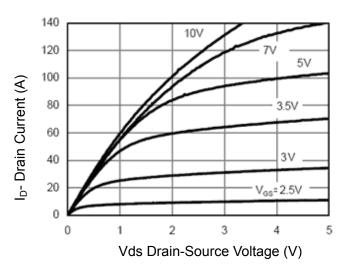


Figure 1 Output Characteristics

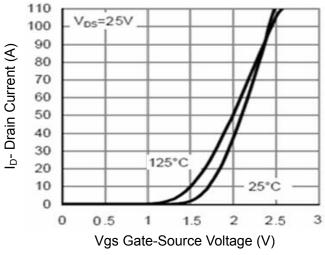


Figure 2 Transfer Characteristics

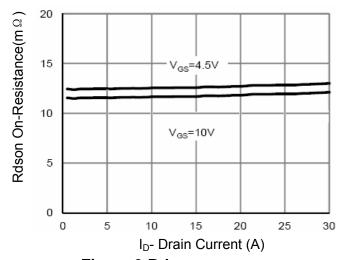


Figure 3 Rdson- Drain Current

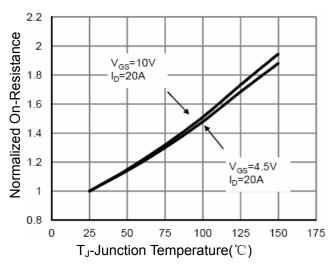


Figure 4 Rdson-JunctionTemperature

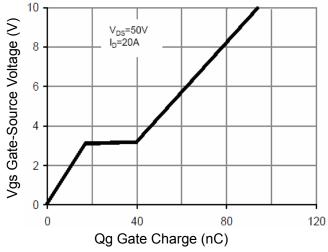


Figure 5 Gate Charge

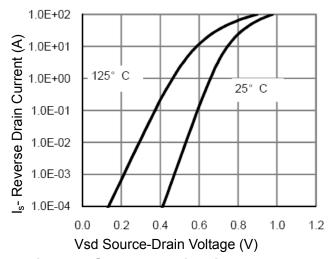


Figure 6 Source- Drain Diode Forward



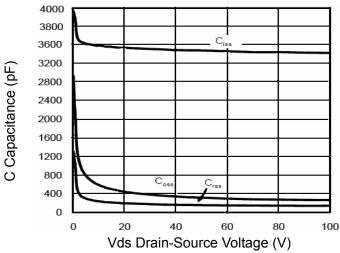


Figure 7 Capacitance vs Vds

1000

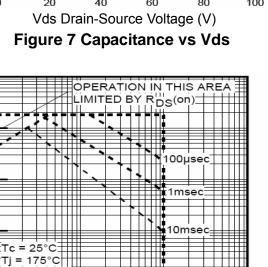
100

10

0.1

Single Pulse

lp- Drain Current (A)



Vds Drain-Source Voltage (V) Figure 8 Safe Operation Area

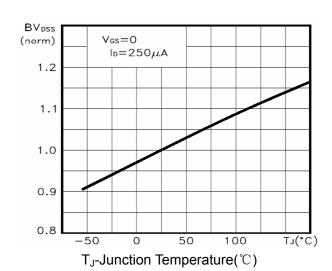


Figure 9 BV_{DSS} vs Junction Temperature

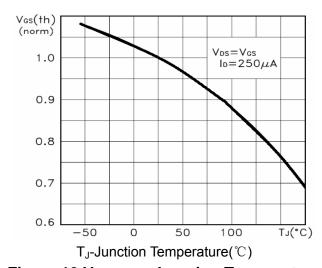


Figure 10 V_{GS(th)} vs Junction Temperature

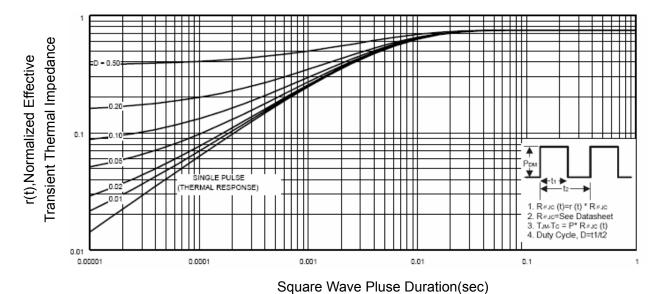
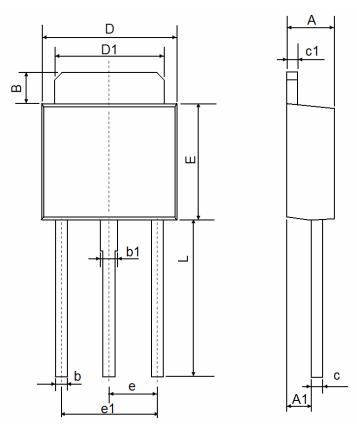


Figure 11 Normalized Maximum Transient Thermal Impedance





TO-251 Package Information



Cumbal	Dimensions I	n Millimeters	Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
Α	2.200	2.400	0.087	0.094	
A1	1.050	1.350	0.042	0.054	
В	1.350	1.650	0.053	0.065	
b	0.500	0.700	0.020	0.028	
b1	0.700	0.900	0.028	0.035	
С	0.430	0.580	0.017	0.023	
c1	0.430	0.580	0.017	0.023	
D	6.350	6.650	0.250	0.262	
D1	5.200	5.400	0.205	0.213	
Е	5.400	5.700	0.213	0.224	
е	2.300 TYP		0.091 TYP		
e1	4.500	4.700	0.177	0.185	
L	7.500	7.900	0.295	0.311	



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